### 250W, 28V High Power RF LDMOS FETs

### Description

The MX0525 is a 250-watt, highly rugged, unmatched LDMOS FET, designed for wideband commercial and industrial applications with frequencies HF to 1 GHz.

•Typical Performance (On Innogration fixture with device soldered):

 $V_{\text{DD}}$  = 28 Volts,  $I_{\text{DQ}}$  = 1200 mA, CW.

Frequency	Gp (dB)	P <sub>-1dB</sub> (W)	η <sub>D</sub> @P <sub>-1</sub> (%)
1000 MHz	17	250	60

•Typical Performance (On Innogration fixture with device soldered):

$V_{22} = 20 V_{0}$	$l_{20} = 1500 m$	
$V_{DD} = 28$ Volts,	IDQ = 1500 m/	A, CVV.

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Freq(MHz)	Gain ( dB )	P-1(W)	Eff(%)	
30	18.9	107	57.5	
100	19.3	204	56.5	
150	18.6	195	56.6	
200	18.5	166	52.5	
250	18.9	141	51.5	
300	18.8	159	54.5	
350	19.1	166	55.6	
400	19.1	155	51.7	
450	19.4	170	51.0	
512	512 20.6		51.7	

• Typical Performance (In Demo Fixture): Pout= 40 Watts @ 30 MHz-512 MHz,

 $V_{DD} = 28$  Volts,  $I_{DQ} = 1.5$  A, Two tone space 100KHz.

Freq(MHz)	30	100	200	300	400	512
IMD3(dBc)	-38	-37	-33	-37	-39	-36

### Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift

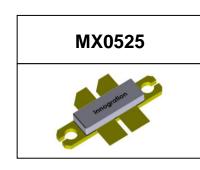
### **Suitable Applications**

- 2-30MHz (HF or Short wave communication)
- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)

#### Table 1. Maximum Ratings

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant
- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)
- 470-860MHz (TV UHF)
- 100kHz 1000MHz (ISM, instrumentation)

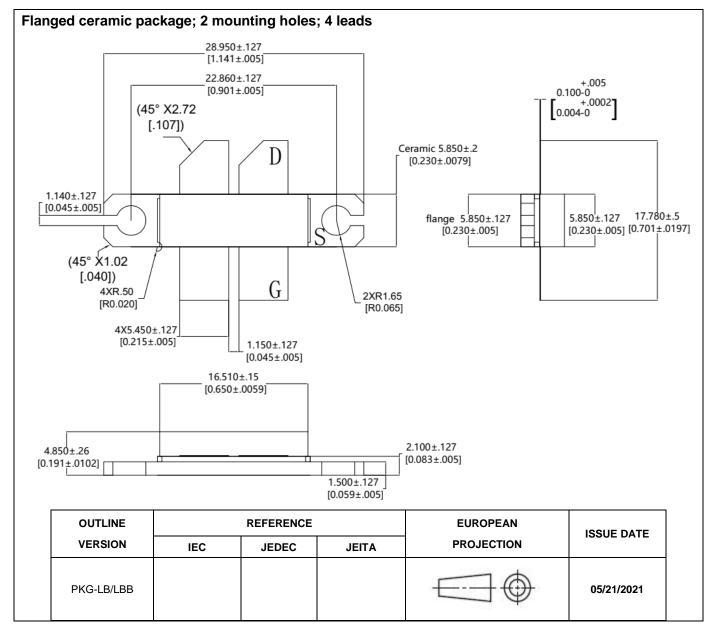
Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	+95	Vdc



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GateSource Voltage	Va	GS		-10 to +10		Vdc	
perating Voltage		DD	+40		Vdc		
Storage Temperature Range		stg -65 to +150		65 to +150	0		
Case Operating Temperature		c		+150		°C	
Operating Junction Temperature	Т	J		+225		°C	
able 2. Thermal Characteristics	•						
Characteristic		Symbol Value		Ur	Unit		
Thermal Resistance, Junction to Case		<b>D</b>					
$T_{C}$ = 85°C, $T_{J}$ =200°C, DC test		Rejc		0.32	°C/W		
able 3. ESD Protection Characteristics	•				•		
Test Methodology				Class			
Human Body Model (per JESD22A114)				Class 2			
able 4. Electrical Characteristics (T <sub>A</sub> = 25 $^{\circ}$ C unless of	herwise no	oted)					
Characteristic		Symbo	ol Min	Тур	Max	Unit	
C Characteristics (per half section)			I	<u> </u>	•		
Drain-Source Voltage							
V <sub>GS</sub> =0, I <sub>DS</sub> =1.0mA		V <sub>(BR)DSS</sub>	ss 90			V	
Zero Gate Voltage Drain Leakage Current							
(V <sub>DS</sub> = 75V, V <sub>GS</sub> = 0 V)		I <sub>DSS</sub>			1	μA	
Zero Gate Voltage Drain Leakage Current		DSS					
(V <sub>DS</sub> = 28 V, V <sub>GS</sub> = 0 V)					1	μA	
GateSource Leakage Current						•	
$(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$		GSS			1	μΑ	
Gate Threshold Voltage		M. au		0.45		N	
$(V_{DS} = 28V, I_D = 650 \ \mu A)$		V <sub>GS</sub> (th	,	2.15		V	
Gate Quiescent Voltage		V <sub>GS(Q)</sub>	(c	2.0		V	
$(V_{DD} = 28 \text{ V}, I_D = 700 \text{ mA}, \text{Measured in Functional Test})$				3.0			
Common Source Input Capacitance		C <sub>ISS</sub>		100		pF	
$(V_{GS} = 0V, V_{DS} = 28 V, f = 1 MHz)$				128			
Common Source Output Capacitance		6		43		pF	
$(V_{GS} = 0V, V_{DS} = 28 V, f = 1 MHz)$		C <sub>oss</sub>		43		рг	
Common Source Feedback Capacitance	C <sub>RSS</sub> 2.4		~~~				
$(V_{GS} = 0V, V_{DS} = 28 V, f = 1 MHz)$				2.4		pF	
unctional Tests (In Demo Test Fixture, 50 ohm system) $V_{\text{DD}}$	= 28 Vdc,	$I_{DQ} = 1200$	) mA, f = 1000 N	IHz, CW Signal	Measurements		
Power Gain		Gp		17		dB	
Drain Efficiency@P1dB				60		%	
1 dB Compression Point				250		W	
Input Return Loss		IRL		-7		dB	
oad Mismatch (In Innogration Test Fixture, 50 ohm system	n): V <sub>DD</sub> =	28 Vdc, I	<sub>pq</sub> = 1200 mA, f	= 1000 MHz			
			ce Degradation				

### **Package Outline**



### **Revision history**

#### Table 5. Document revision history

Date	Revision	Datasheet Status
2017/10/13	Rev 1.0	Product Datasheet
2021/5/21	Rev 1.1	Package outline update

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